

X00619

0.8 A sensitive gate SCR

Features

- $I_{T(RMS)} = 0.8 A$
- \blacksquare $V_{DRM} / V_{RRM} = 600 V$
- $I_{GT} = 30 \text{ to } 200 \mu A$

Applications

- Limited gate current topologies
- Ground fault circuit interrupters
- Overvoltage crowbar protection in power supplies
- Protection in electronic ballasts
- Capacitive discharge ignitions
- Ignitors (lighting, oven...)

Description

The X006 SCR can be used as on/off function in applications where topology does not offer high current for gate triggering.

This device is optimized in forward voltage drop and inrush current capabilities for reduced power losses and high reliability in harsh environments.

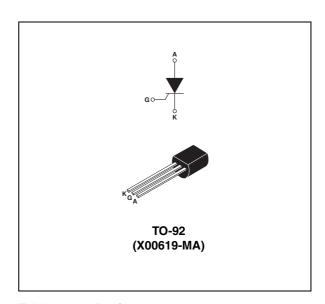


Table 1. Device summary

| I _{T(RMS)} | 0.8 A |
|---------------------|--------------|
| V_{DRM} / V_{RRM} | 600 V |
| I _{GT} | 30 to 200 μA |

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1 Characteristics

Table 2. Absolute ratings (limiting values, $T_J = 25$ °C unless otherwise specified)

| Symbol | Parameter | | | | Unit |
|------------------------------------|---|------------------------|-------------------------|--------------------------------|------------------|
| I _{T(RMS)} | On-state rms current (180 °Conduction angle) | T _L = 85 °C | 0.8 | Α | |
| IT _(AV) | Average on-state current (180 °Conduction angle) | | T _L = 85 °C | 0.5 | Α |
| | I _{TSM} Non repetitive surge peak on-state current | | T _ 05 °C | 10 | Α |
| ITSM | | | T _j = 25 °C | 9 | A |
| l ² t | I^2t Value for fusing $t_p = 10 \text{ ms}$ | | T _j = 25 °C | 0.4 | A ² s |
| di/dt | Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \le 100 \text{ ns}$ $F = 60 \text{ F}$ | | T _j = 125 °C | 50 | A/µs |
| I _{GM} | Peak gate current $t_p = 20 \mu s$ | | T _j = 125 °C | 1 | Α |
| P _{G(AV)} | Average gate power dissipation $T_j = 125^{\circ}$ | | | 0.1 | W |
| T _{stg} T _j | Storage junction temperature range Operating junction temperature range | | | - 40 to + 150 - 40 to + 125 | °C |

Table 3. Electrical characteristics ($T_J = 25$ °C unless otherwise specified)

| Symbol | ol Test conditions | | | Value | Unit |
|-----------------|---|--|--------|-------|------|
| 1 | | | MIN. | 30 | μA |
| I _{GT} | $V_D = 12 \text{ V}, R_L = 140 \Omega$ | | MAX. | 200 | μА |
| V _{GT} | | | IVIAA. | 0.8 | V |
| V _{GD} | $V_D = V_{DRM,} \; R_L = 3.3 \; k\Omega$, $R_{GK} = 1 \; k\Omega$ $T_j = 125 \; ^{\circ}C$ | | MIN. | 0.2 | V |
| V_{RG} | I _{RG} = 10 μA | | MIN. | 5 | V |
| I _H | $I_T = 50 \text{ mA}, R_{GK} = 1 \text{ k}\Omega$ | | MAX. | 5 | mA |
| IL | $I_G = 1$ mA, $R_{GK} = 1$ k Ω | | MAX. | 6 | mA |
| dV/dt | $V_D = 67\% V_{DRM,} R_{GK} = 1 k\Omega$ $T_j = 125 °C$ | | MIN. | 40 | V/µs |

Table 4. Static electrical characteristics (per diode)

| (per array) | | | | | |
|-----------------------------------|---|--------------------------|-----|-------|------|
| Symbol | Test conditions | | | Value | Unit |
| V _{TM} | $I_{TM} = 1 \text{ A, t}_p = 380 \mu\text{s}$ | T _j = 25 °C | | 1.35 | V |
| V _{TO} | Threshold voltage | T _i = 125 °C | | 0.85 | V |
| Rd | Dynamic resistance | - 1 _j = 125 C | MAX | 245 | mΩ |
| I _{DRM} I _{RRM} | $V_{DRM} = V_{RRM}, R_{GK} = 1 \text{ k}\Omega$ | T _j = 25 °C | | 1 | μΑ |
| | | T _j = 125 °C | | 100 | μΑ |

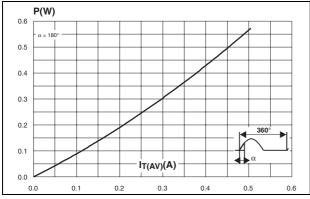
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Table 5. Thermal resistances

| Symbol | Parameter | Value | Unit |
|----------------------|--------------------------|-------|------|
| R _{th(j-a)} | Junction to ambient (DC) | 150 | °C/W |
| R _{th(j-l)} | Junction to lead (DC) | 70 | C/VV |

Figure 1. Maximum average power dissipation vs. average on-state current

Figure 2. Average and DC on-state current vs. case temperature



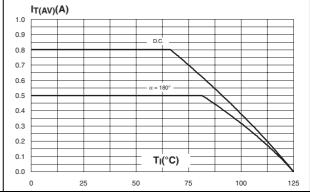
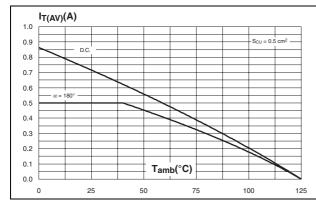
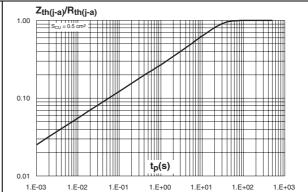


Figure 3. Average and DC on-state current vs. case temperature

Figure 4. Relative variation of thermal impedance junction to ambient vs. pulse duration

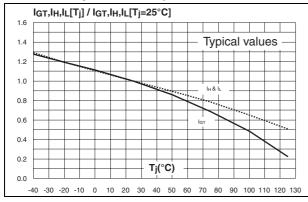




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Figure 5. Relative variation of gate trigger, holding and latching current vs. junction temperature

Figure 6. Relative variation of holding current vs. gate-cathode resistance (typical values)



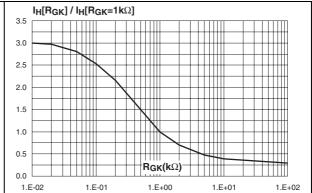
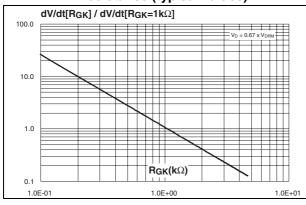


Figure 7. Relative variation of dV/dt immunity vs. gate-cathode resistance (typical values)

Figure 8. Relative variation of dV/dt immunity vs. gate-cathode capacitance (typical values)



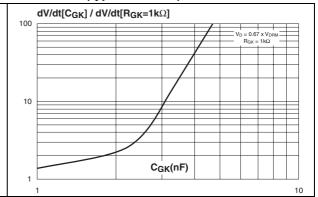
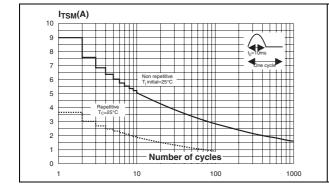
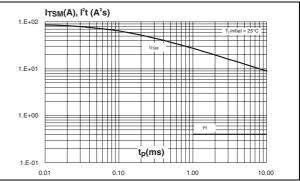


Figure 9. Surge peak on-state current vs. number of cycles

Figure 10. Non repetitive surge peak on state current for a sinusoidal pulse and corresponding value of I²T





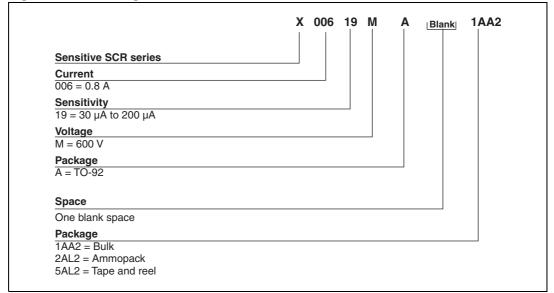
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I_{TM}(A) 10.00 0.0 0.2 0.4 0.6 0.8 1.0 1.2 1.4 1.6 1.8 2.0 2.2 2.4 2.6 2.8 3.0

Figure 11. On-state characteristics (maximum values)

Ordering information scheme 2

Figure 12. Ordering information scheme

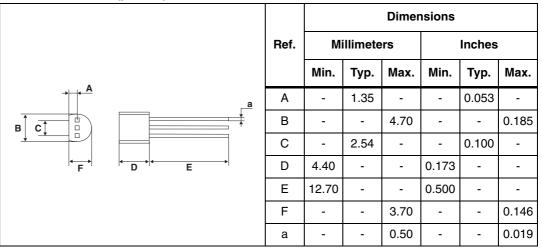


3 Package information

Epoxy meets UL94, V0

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 6. TO-92 (plastic) dimensions



4 Ordering information

Table 7. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|---------------|----------|---------|--------|----------|---------------|
| X00619MA 1AA2 | | | | 2500 | Bulk |
| X00619MA 2AL2 | X0619 MA | TO-92 | 0.2 g | 2000 | Ammopack |
| X00619MA 5AL2 | | | | 2000 | Tape and reel |

5 Revision history

Table 8. Document revision history

| Date | Revision | Changes |
|-------------|----------|-------------|
| 26-May-2009 | 1 | First issue |

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